Unit: mm



TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ($L^2-\pi$ -MOSV)

2SK2233

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain-source ON resistance : $RDS(ON) = 0.022 \Omega \text{ (typ.)}$

 $\bullet~$ High forward transfer admittance ~ : $|\,Y_{fs}\,|$ = 27 S (typ.)

• Low leakage current : $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 60 \text{ V)}$

• Enhancement-mode $: V_{th} = 0.8 \sim 2.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	60	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	45	Α	
	Pulse (Note 1)	I _{DP}	180	Α	
Drain power dissipation (Tc = 25°C)		P_{D}	100	W	
Single pulse avalanche energy (Note 2)		E _{AS}	246	mJ	
Avalanche current		I _{AR}	45	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	10	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Weight: 4.6 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.25	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25 °C (initial), L = 165 μ H, R_{G} = 25 Ω , I_{AR} = 45 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device.

Please handle with caution.



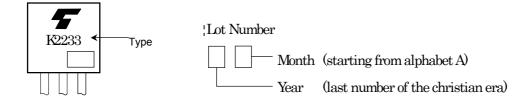
Electrical Characteristics (Ta = 25°C)

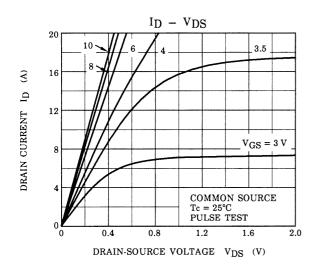
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br voltage	eakdown	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	60	_	-	٧
Gate threshold v	oltage/	V _{th}	V _{DS} = 10 V, I _D = 1 mA	8.0	_	2.0	V
Drain-source ON resistance		Dec (con)	V _{GS} = 4 V, I _D = 15 A	_	40	55	mΩ
		R _{DS} (ON)	V _{GS} = 10 V, I _D = 25 A	_	22	30	
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 25 A	15	27	_	S
Input capacitano	e	C _{iss}		_	1800	_	
Reverse transfer capacitance Output capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	350	_	pF
		C _{oss}		_	900	_	
Switching time	Rise time	t _r	VGS OV ID=25A VOUT RL= 1.2Ω	_	20	_	
	Turn-on time	t _{on}			30		ne
	Fall time	t _f		l	40	l	ns
	Turn-off time	t _{off}	$V_{DD} = 30V$ Duty $\leq 1\%$, $t_w = 10 \mu s$		130		
Total gate charge (Gate-source plus gate-drain)		Qg			60		
Gate-source charge		Q _{gs}	$V_{DD} \approx 48 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 45 \text{ A}$	_	40	_	nC
Gate-drain ("miller") charge		Q _{gd}			20	_	

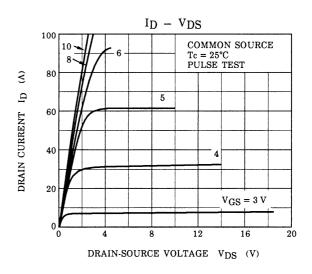
Source-Drain Ratings and Characteristics (Ta = 25°C)

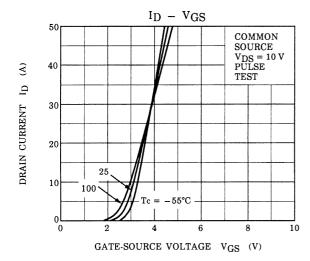
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	-	_	45	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	-	_	180	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 45 A, V _{GS} = 0 V	_	_	-1.8	V
Reverse recovery time	t _{rr}	I _{DR} = 45 A, V _{GS} = 0 V		90	_	ns
Reverse recovered charge	Qrr	dl _{DR} / dt = 100 A / μs	1	0.1	_	μC

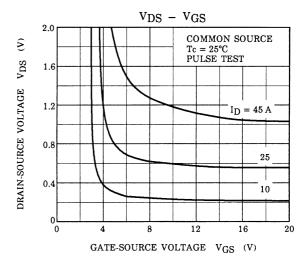
Marking

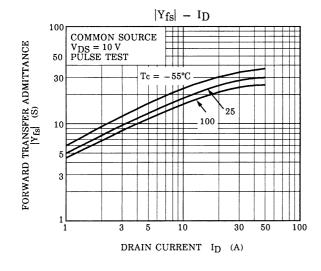


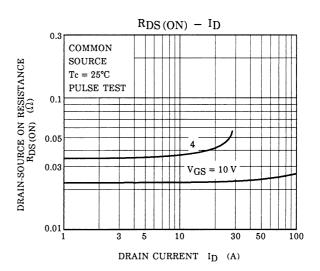


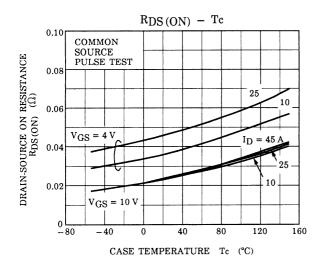


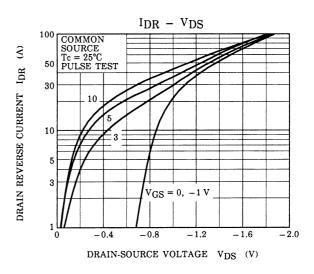


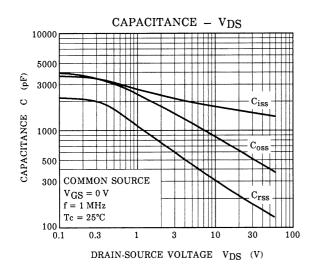


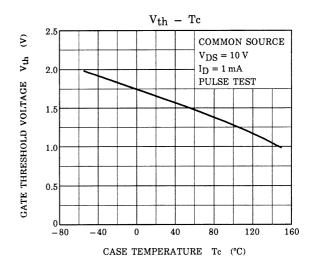


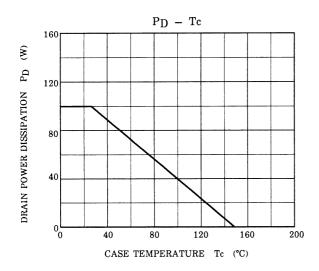


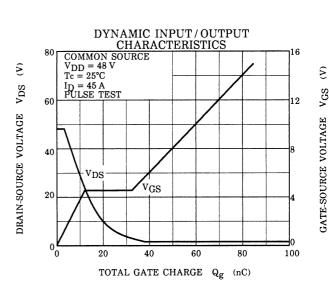


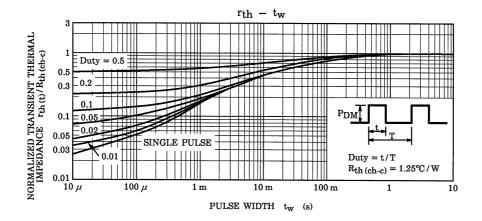


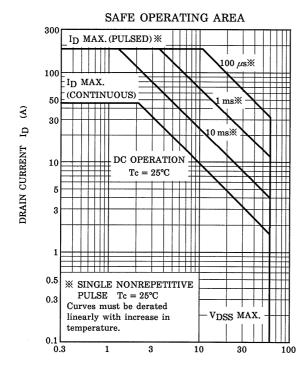


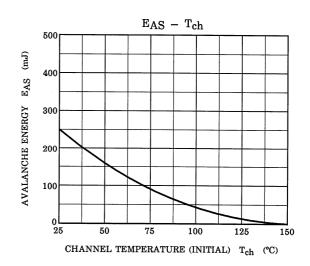


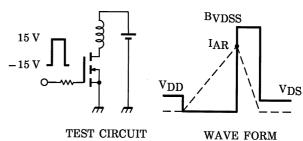












$$\begin{aligned} R_G &= 25 \ \Omega \\ V_{DD} &= 25 \ V, \ L = 165 \ \mu H \end{aligned} \qquad E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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